

Silicon N Channel MOS FET High speed power Switching

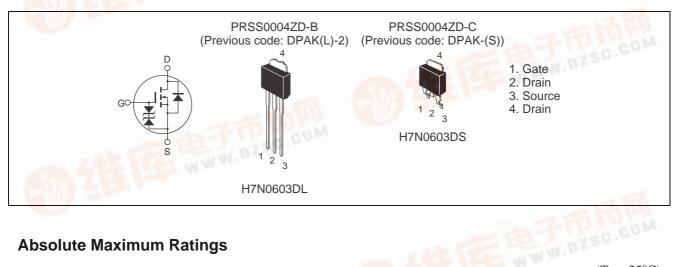
> REJ03G0123-0200 Rev.2.00 Jan.26.2005

WWW.DZSC

#### **Features**

- Low on resistance  $R_{DS}$  (on) = 11 m $\Omega$  typ.
- Low drive current
- Capable of 4.5 gate drive •

### Outline



### **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
ltem	Symbol	Ratings	Unit
Drain to source voltage	VDSS	60	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	ID	30	А
Drain peak current	I <sub>D</sub> (pulse) Note1	120	А
Body drain diode reverse drain current	I <sub>DR</sub>	30	A
Avalanche current	I <sub>AP</sub> <sup>Note3</sup>	25	A
Avalanche energy	E <sub>AR</sub> <sup>Note3</sup>	53.6	mJ
Channel dissipation	Pch <sup>Note2</sup>	40	W
Channel temperature	Tch	<u>15</u> 0	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

3. Tch =  $25^{\circ}$ C, Rg  $\geq 50\Omega$ 

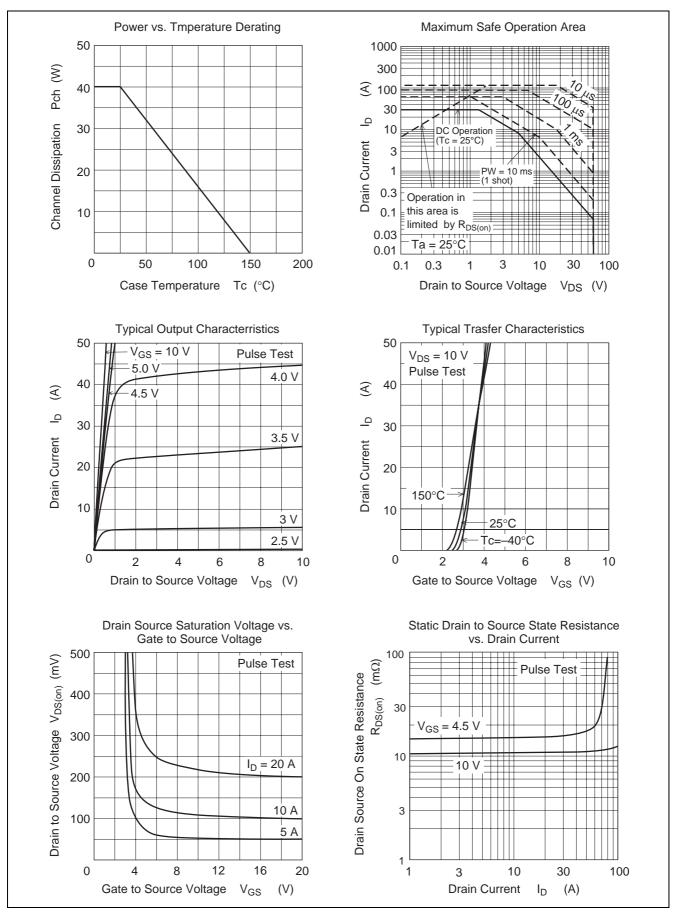


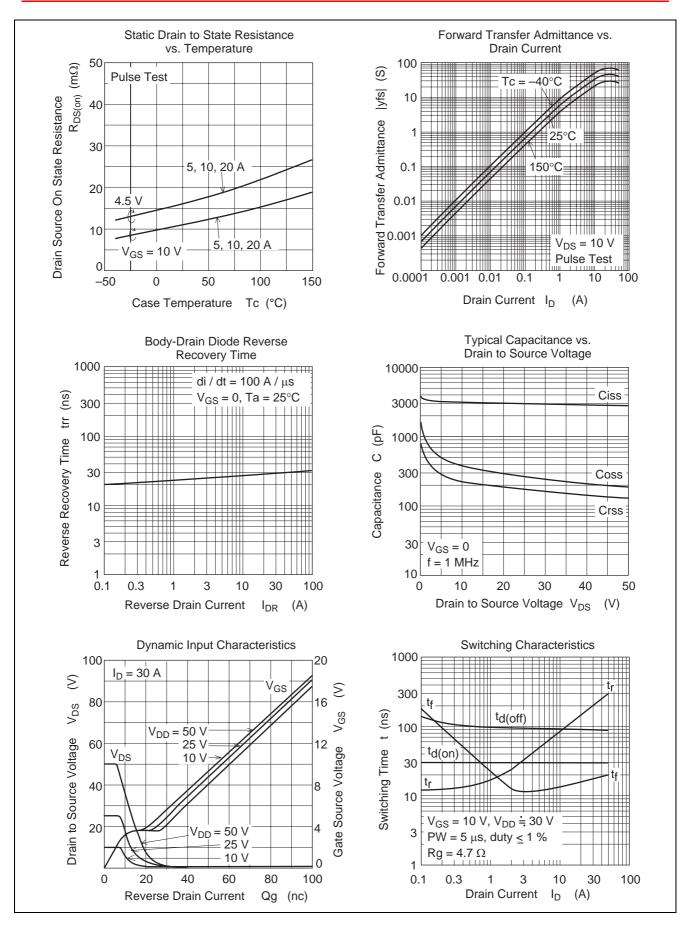
## **Electrical Characteristics**

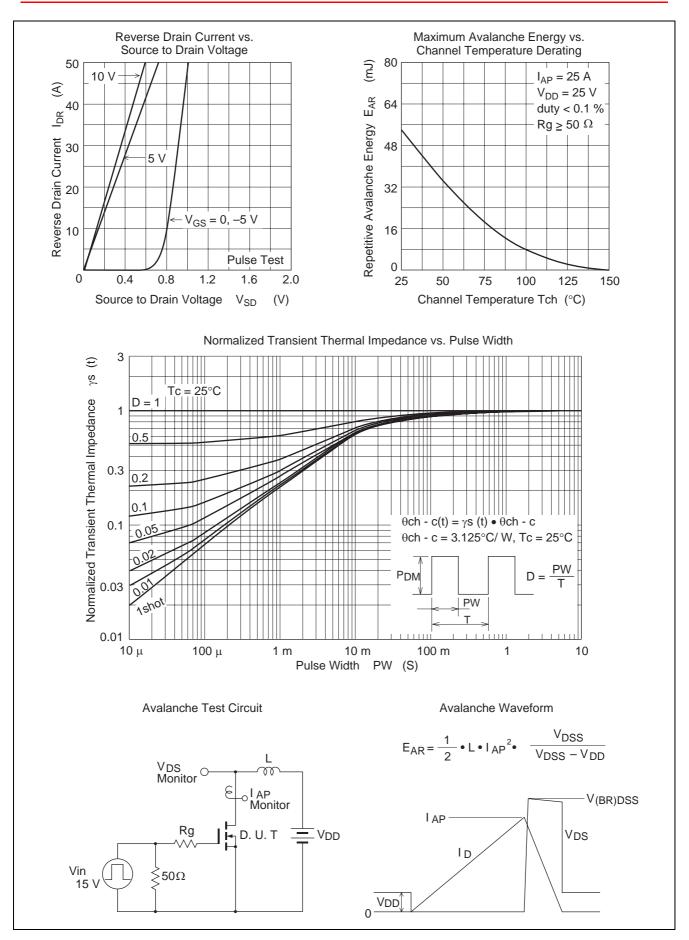
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test condition
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	60	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—	—	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>		—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>		—	10	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.5	—	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R <sub>DS(on)</sub>		11	15	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note1}}$
resistance			16	22	mΩ	$I_D = 15 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note1}}$
Forward transfer capacitance	y <sub>fs</sub>	24	40	—	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note1}}$
Input capacitance	Ciss	_	3200	—	pF	$V_{DS} = 10 V$ $V_{GS} = 0$ $f = 1 MHz$
Output capacitance	Coss		385	—	pF	
Reverse transfer capacitance	Crss		225		pF	
Total gate charge	Qg	_	56	—	nC	$V_{DD} = 25 V$ $V_{GS} = 10 V$ $I_D = 30 A$
Gate to source charge	Qgs		11	—	nC	
Gate to drain charge	Qgd		12	_	nC	
Turn-on delay time	t <sub>d(on)</sub>	_	30	_	ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$
Rise time	tr		125	—	ns	$R_{L} = 2.0 \Omega$ $Rg = 4.7 \Omega$
Turn-off delay time	t <sub>d(off)</sub>		90	_	ns	
fall time	t <sub>f</sub>		17	_	ns	
Body - drain diode forward voltage	V <sub>DF</sub>	_	0.9	—	V	$I_F = 30 \text{ A}, V_{GS} = 0^{\text{Note1}}$
Body – drain diode reverse recovery	t <sub>rr</sub>		30	_	ns	$I_F = 30 \text{ A}, V_{GS} = 0$
time						diF / dt = 100 A / μs

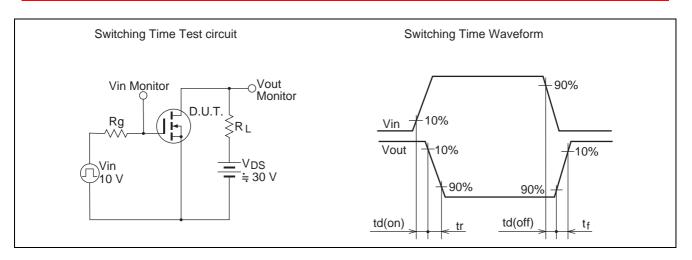
Notes: 1. Pulse Test

### **Main Characteristics**



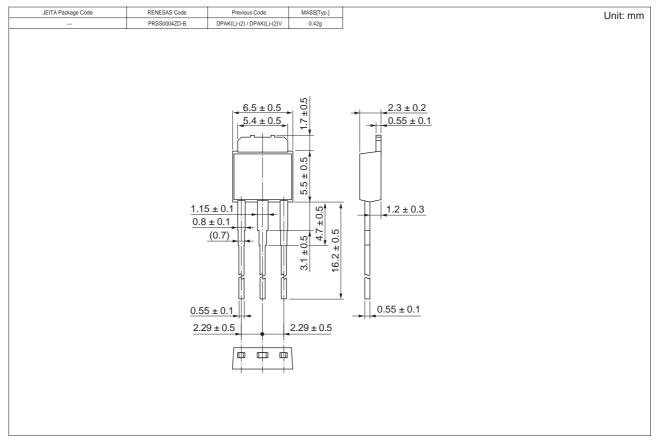






### **Package Dimensions**

#### • H7N0603DL



#### • H7N0603DS

SC-63 PRESERVAZDC DPAK[S]/ DPAK[S]/ DPAK[S]/ DPAK[S]/ DPAK[S]/ DPAK[S]/ DPAK[S]/ DPAK[S]/ DPAK[S]/ 0.28g Offer the second secon	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]		l leite en
		PRS50004ZD-C	<u>6.5 ± 0.5</u>	0.28g	$\underbrace{2.3 \pm 0.2}_{0.55 \pm 0.1}$ (5.1)	Unit: m
		5.5±0.5				
		(				

### **Ordering Information**

Part Name	Quantity	Shipping Container
H7N0603DL	100 pcs	Sack
H7N0603DSTL	3000 pcs	Taping
H7N0603DL-E	100 pcs	Sack
H7N0603DSTL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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